

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Seng Guan Chow</td> <td>08/24/2006</td> </tr> <tr> <td>Francis Heap Hoe Kuan</td> <td>08/24/2006</td> </tr> </tbody> </table>		Name	Execution Date	Seng Guan Chow	08/24/2006	Francis Heap Hoe Kuan	08/24/2006
Name	Execution Date						
Seng Guan Chow	08/24/2006						
Francis Heap Hoe Kuan	08/24/2006						
RECEIVING PARTY DATA							
Name:	STATS ChipPAC, Inc.						
Street Address:	47400 Kato Road						
City:	Fremont						
State/Country:	CALIFORNIA						
Postal Code:	94538						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11521974</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11521974		
Property Type	Number						
Application Number:	11521974						
CORRESPONDENCE DATA							
Fax Number:	(503)595-5301						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	503-595-5300						
Email:	valerie.sullivan@klarquist.com						
Correspondent Name:	A. Jonathan Vance of Klarquist Sparkman						
Address Line 1:	One World Trade Center, Suite 1600						
Address Line 2:	121 SW Salmon St.						
Address Line 4:	Portland, OREGON 97204						
ATTORNEY DOCKET NUMBER:	7660-75917-01						
NAME OF SUBMITTER:	A. Jonathan Vance						

Total Attachments: 3
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**PATENT
 REEL: 018435 FRAME: 0348**

CH \$40.00 11521974

A S S I G N M E N T

WHEREAS, we, Seng Guan Chow, of city/state of Singapore, and Francis Heap Hoe Kuan, of city/state of Singapore, have invented a certain invention, entitled SEMICONDUCTOR ASSEMBLY WITH COMPONENT ATTACHED ON DIE BACK SIDE, for which we are making application for letters patent of the United States, said application having been executed by us on the 24th day of August, 2006; and

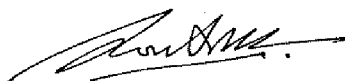
WHEREAS, STATS ChipPAC, Inc., a corporation organized under the laws of the State of Delaware, having a place of business at 47400 Kato Road, Fremont, California 94538, desires to acquire an interest therein:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we, Seng Guan Chow and Francis Heap Hoe Kuan, hereby sell, assign and transfer to STATS ChipPAC, Inc., the full and exclusive right, title and interest in and to said invention, patent application and patent rights throughout the world, including foreign patent priority rights, the right to file and prosecute International Applications under the Patent Cooperation Treaty, and the right to file and prosecute applications under the European Patent Convention; said invention, application and letters patent in this or any foreign country, and all divisions, continuations, reissues and extensions thereof, to be held and enjoyed by STATS ChipPAC, Inc., for its own use and benefit, and for its successors and assigns to the full end of the term for which letters patent may be granted in this or any foreign country, as fully and entirely as the same would have been held by us had this assignment and sale not been made, and covenant that we have full right so to do, and agree that we will communicate to STATS

ChipPAC, Inc., or its successors and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths, and do everything possible to aid STATS ChipPAC, Inc., its successors and assigns to obtain and enforce proper patent protection for said invention in this or any foreign country.

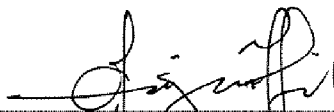
We hereby grant the law firm of Klarquist Sparkman, LLP, the power to insert on this Assignment any further information which may be necessary or desirable in order to comply with all applicable legal requirements, including the rules of the United States Patent and Trademark Office, for submitting and recording this document.

Executed at the place and date opposite our respective signatures below.

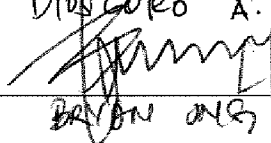


Seng Guan Chow

This 24 day of August, 2006, before me personally came the above-named Seng Guan Chow, who executed the foregoing Assignment in my presence, and who acknowledged to me that such person executed the same of their own free will for the purposes set forth therein.



Witness DIOSCORO A. MERILO



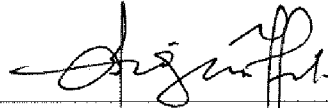
Witness

BRYAN ONG

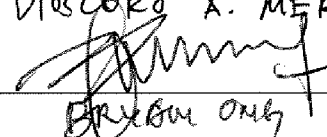


Francis Heap Hoe Kuan

This 24 day of August, 2006, before me personally came the above-named Francis Heap Hoe Kuan, who executed the foregoing Assignment in my presence, and who acknowledged to me that such person executed the same of their own free will for the purposes set forth therein.



Witness DIOSCORO A. MERILO



Witness

Brian O'Neil